PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
JUNG-HUA CHANG	06/02/2017
JING-CHENG LIN	06/02/2017
PO-HAO TSAI	06/02/2017

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.
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Internal Address:	HSINCHU SCIENCE PARK
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State/Country:	TAIWAN
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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15609523

CORRESPONDENCE DATA

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NAME OF SUBMITTER:	DERYA SEVINC
SIGNATURE:	/Derya Sevinc/
DATE SIGNED:	06/08/2017

Total Attachments: 2

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PATENT 504404283 REEL: 042651 FRAME: 0147

ASSIGNMENT

WHEREAS, Jung-Hua CHANG, Jing-Cheng LIN, and Po-Hao TSAI

hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: SEMICONDUCTOR PACKAGE STRUCTURE WITH CONDUCTIVE LINE AND

METHOD FOR FORMING THE SAME		
Filed: May 31, 2017	Serial No. 15/609,523	
Executed on: June 2, 2017		

WHEREAS, <u>Taiwan Semiconductor Manufacturing Co., Ltd.</u>, of <u>No. 8, Li-Hsin Rd. 6, Hsinchu Science Park, Hsinchu 300-78, Taiwan R.O.C.</u>, hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

ASSIGNMENT

Date

Tung-Hua Chang

Name: Jung-Hua CHANG (Last name: CHANG)

Told

Date

Name: Jing-Chang

(Last name: LIN)

Po-Hao Tsa;

Name: Po-Hao Tsai

(Last name: Tsai)

P20161075US00/0503-B31788-US RECORDED: 06/08/2017

PATENT REEL: 042651 FRAME: 0149